

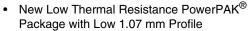


N-Channel 20-V (D-S) Fast Switching MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)	Q _g (Typ.)		
20	0.0062 at V _{GS} = 4.5 V	19.5	17.5 nC		
	0.0098 at $V_{GS} = 2.5 \text{ V}$	15.5	17.5110		

FEATURES

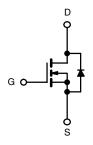
- Halogen-free Option Available
- TrenchFET[®] Power MOSFET



- PWM Optimized
- 100 % R_g Tested

APPLICATIONS

· Synchronous Rectification



N-Channel MOSFET

PowerPAK 1212-8
3.30 mm 3.30 mm 2 3.30 mm

Ordering Information: Si7106DN-T1-E3 (Lead (Pb)-free)

Bottom View

Si7106DN-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS	T _A = 25 °C, unles	ss otherwise n	oted		_
Parameter		Symbol	10 s	Steady State	Unit
Drain-Source Voltage		V_{DS}	20		V
Gate-Source Voltage		V_{GS}	± 12		
O D . O (T 150.00)3	T _A = 25 °C	I _D	19.5	12.5	
Continuous Drain Current $(T_J = 150 ^{\circ}C)^a$	T _A = 70 °C		15.6	10.0	
Pulsed Drain Current		I _{DM}	60		Α
Continuous Source Current (Diode Conduction) ^a		I _S	3.2	1.3	
Single Avalanche Current	L = 0.1 mH	I _{AS}	30		
Single Avalanche Energy	L=UIIIII	E _{AS}	45		mJ
W	T _A = 25 °C	P _D	3.8	1.5	W
Maximum Power Dissipation ^a	T _A = 70 °C		2.0	0.8	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C
Soldering Recommendations (Peak Temperature)b, c			260		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Mariana kantina ta Andria 18	t ≤ 10 s	R _{thJA}	24	33	°C/W	
Maximum Junction-to-Ambient ^a	Steady State		65	81		
Maximum Junction-to-Case (Drain)	Steady State		1.9	2.4		

Notes:

- a. Surface Mounted on 1" x 1" FR4 board.
- b. See Solder Profile (http://www.vishay.com/ppg?73257). The PowerPAK 1212-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- c. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

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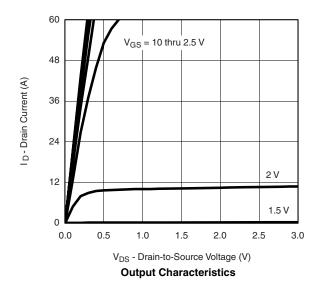
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static			•	•	,		
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	0.6		1.5	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 20 V, V _{GS} = 0 V	1		1		
		$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			μA		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	40			Α	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 19.5 A		0.0051	0.0062	Ω	
		$V_{GS} = 2.5 \text{ V}, I_D = 15.5 \text{ A}$		0.0081	0.0098		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 19.5 A		105		S	
Diode Forward Voltage ^a	V_{SD}	$I_S = 3.2 \text{ A}, V_{GS} = 0 \text{ V}$		0.8	1.2	٧	
Dynamic ^b			•				
Total Gate Charge	Q_g			17.5	27		
Gate-Source Charge	Q_{gs}	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 19.5 \text{ A}$		6.6		nC	
Gate-Drain Charge	Q _{gd}			2.8			
Gate Resistance	R_g	f = 1 MHz	0.7	1.4	2.1	Ω	
Turn-On Delay Time	t _{d(on)}			25	40		
Rise Time t		V_{DD} = 10 V, R_L = 10 Ω		15	25	ns	
Turn-Off Delay Time	t _{d(off)}	$t_{d(off)}$ $I_D \approx 1 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 6 \Omega$		50	75		
Fall Time	t _f			12	20	1	
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 3.2 A, dI/dt = 100 A/μs		30	60		

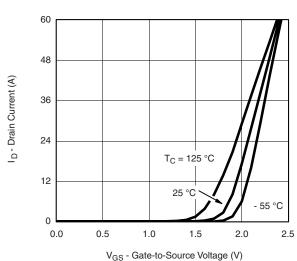
Notes:

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





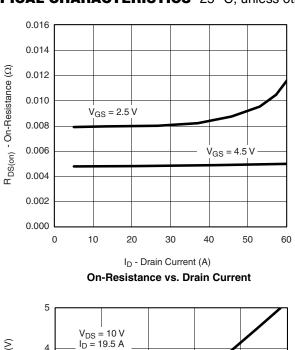
Transfer Characteristics

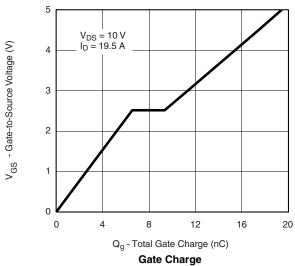


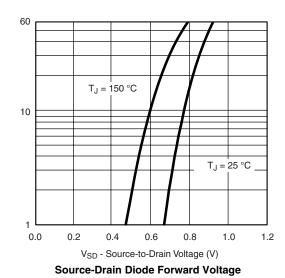


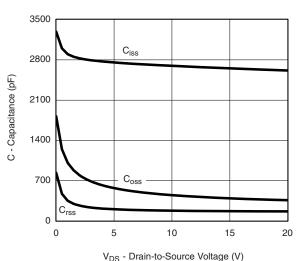


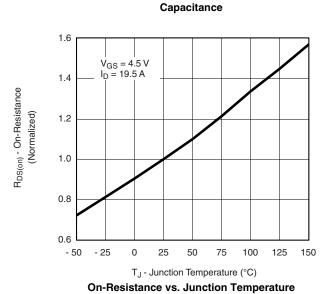
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

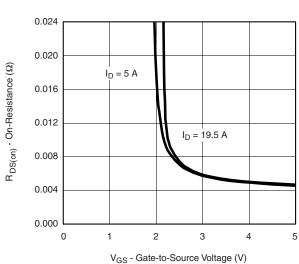












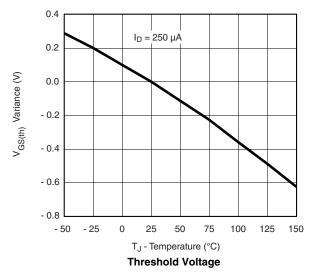
On-Resistance vs. Gate-to-Source Voltage

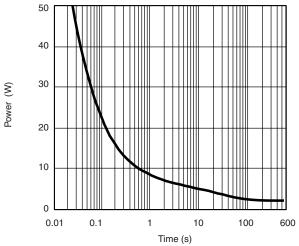
Is - Source Current (A)

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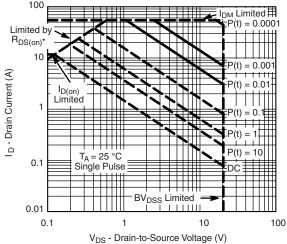
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



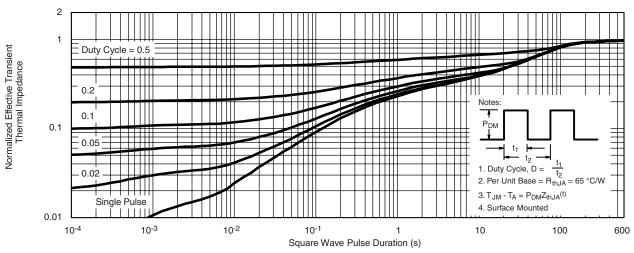


Single Pulse Power, Junction-to-Ambient



* V_{GS} > minimum V_{GS} at which R_{DS(on)} is specified

Safe Operating Area



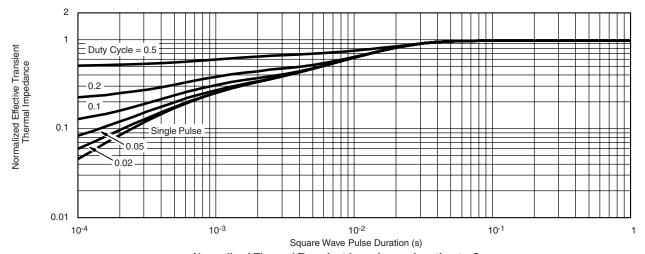
Normalized Thermal Transient Impedance, Junction-to-Ambient







TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Case

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Document Number: 73142 S-81529-Rev. E, 30-Jun-08



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Revision: 18-Jul-08

Document Number: 91000 www.vishay.com

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Vishay: SI7106DN-T1-GE3